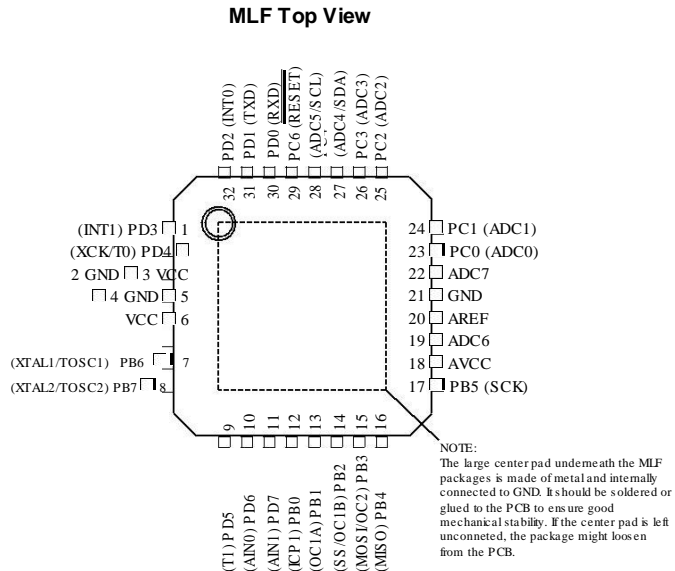
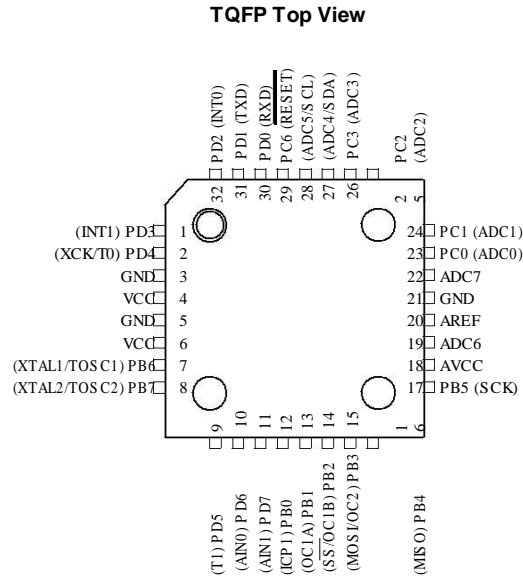
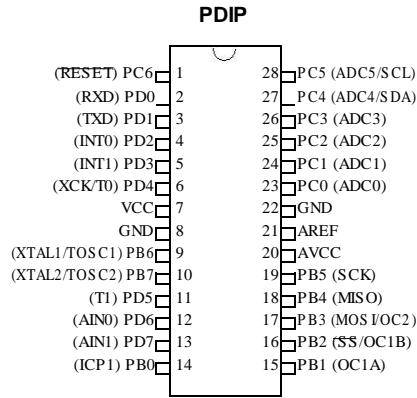


ATMEGA8 SPECIFICATION

Features

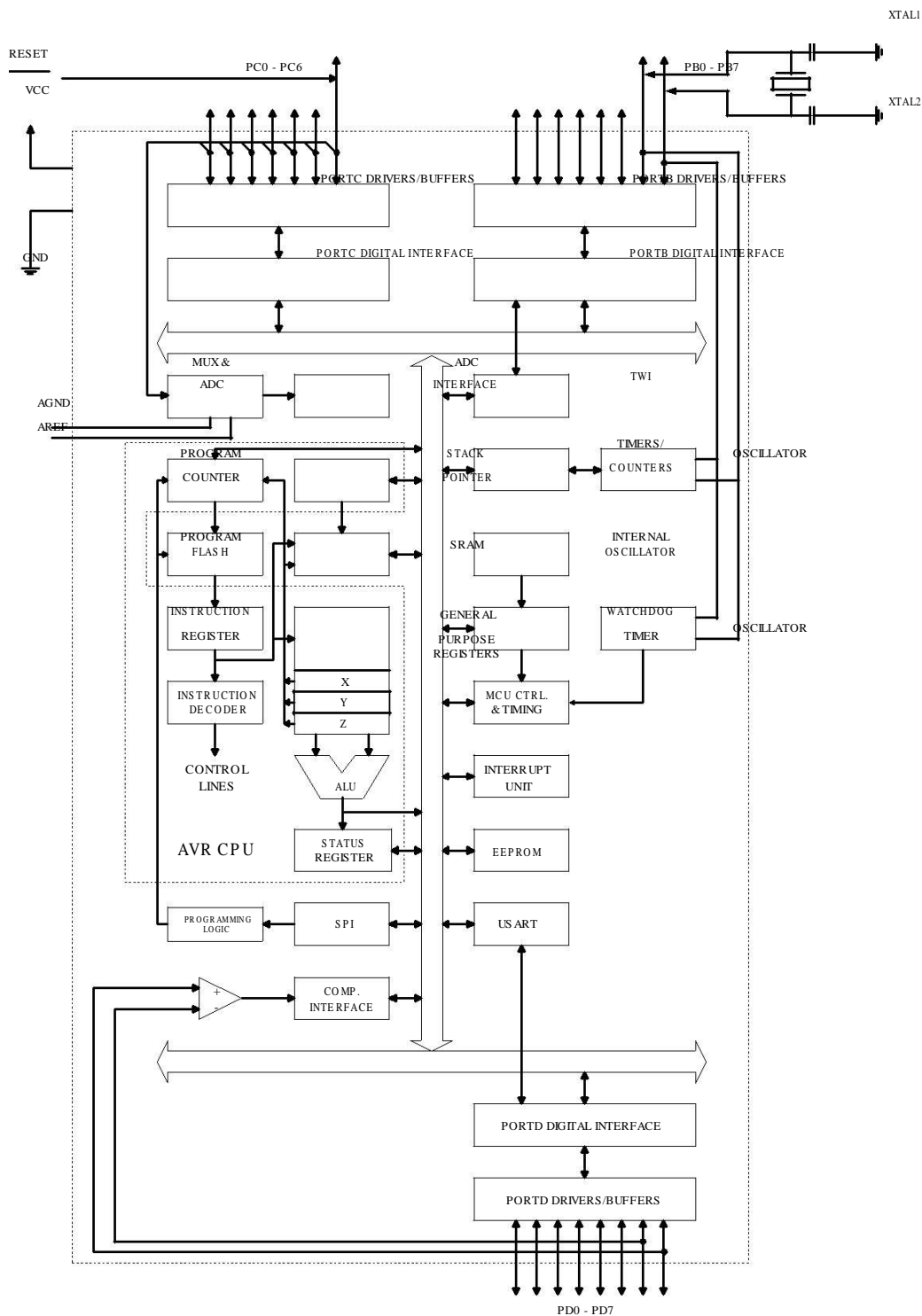
- High-performance, Low-power AVR[®] 8-bit Microcontroller
- Advanced RISC Architecture
 - 130 Powerful Instructions – Most Single-clock Cycle Execution
 - 32 x 8 General Purpose Working Registers
 - Fully Static Operation
 - Up to 16 MIPS Throughput at 16 MHz
 - On-chip 2-cycle Multiplier
- Nonvolatile Program and Data Memories
 - 8K Bytes of In-System Self-Programmable Flash
Endurance: 10,000 Write/Erase Cycles
 - Optional Boot Code Section with Independent Lock Bits
In-System Programming by On-chip Boot Program
True Read-While-Write Operation
 - 512 Bytes EEPROM
Endurance: 100,000 Write/Erase Cycles
 - 1K Byte Internal SRAM
 - Programming Lock for Software Security
- Peripheral Features
 - Two 8-bit Timer/Counters with Separate Prescaler, one Compare Mode
 - One 16-bit Timer/Counter with Separate Prescaler, Compare Mode, and Capture Mode
 - Real Time Counter with Separate Oscillator
 - Three PWM Channels
 - 8-channel ADC in TQFP and QFN/MLF package
Eight Channels 10-bit Accuracy
 - 6-channel ADC in PDIP package
Eight Channels 10-bit Accuracy
 - Byte-oriented Two-wire Serial Interface
 - Programmable Serial USART
 - Master/Slave SPI Serial Interface
 - Programmable Watchdog Timer with Separate On-chip Oscillator
 - On-chip Analog Comparator
- Special Microcontroller Features
 - Power-on Reset and Programmable Brown-out Detection
 - Internal Calibrated RC Oscillator
 - External and Internal Interrupt Sources
 - Five Sleep Modes: Idle, ADC Noise Reduction, Power-save, Power-down, and Standby
- I/O and Packages
 - 23 Programmable I/O Lines
 - 28-lead PDIP, 32-lead TQFP, and 32-pad QFN/MLF
- Operating Voltages
 - 2.7 - 5.5V (ATmega8L)
 - 4.5 - 5.5V (ATmega8)
- Speed Grades
 - 0 - 8 MHz (ATmega8L)
 - 0 - 16 MHz (ATmega8)
- Power Consumption at 4 Mhz, 3V, 25°C
 - Active: 3.6 mA
 - Idle Mode: 1.0 mA
 - Power-down Mode: 0.5 µA

Pin Configurations



- Block Diagram

Figure 1. Block Diagram



• Ordering Information

Speed (MHz)	Power Supply	Ordering Code	Package ⁽¹⁾	Operation Range
8	2.7 - 5.5	ATmega8L-8AC	32A	Commercial (0°C to 70°C)
		ATmega8L-8PC	28P3	
		ATmega8L-8MC	32M1-A	
		ATmega8L-8AI	32A	Industrial (-40°C to 85°C)
		ATmega8L-8AU ⁽²⁾	32A	
		ATmega8L-8PI	28P3	
ATmega8L-8PU ⁽²⁾	28P3			
ATmega8L-8MI	32M1-A			
ATmega8L-8MU ⁽²⁾	32M1-A			
16	4.5 - 5.5	ATmega8-16AC	32A	Commercial (0°C to 70°C)
		ATmega8-16PC	28P3	
		ATmega8-16MC	32M1-A	
		ATmega8-16AI	32A	Industrial (-40°C to 85°C)
		ATmega8-16AU ⁽²⁾	32A	
		ATmega8-16PI	28P3	
ATmega8-16PU ⁽²⁾	28P3			
ATmega8-16MI	32M1-A			
ATmega8-16MU ⁽²⁾	32M1-A			

Notes: 1. This device can also be supplied in wafer form. Please contact your local Atmel sales office for detailed ordering information and minimum quantities.

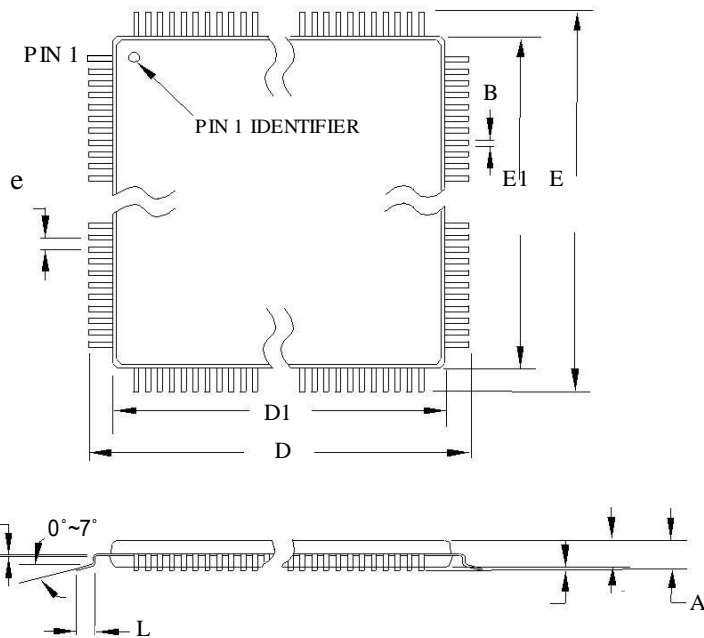
2. Pb-free packaging alternative, complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.

Package Type	
32A	32-lead, Thin (1.0 mm) Plastic Quad Flat Package (TQFP)
28P3	28-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)
32M1-A	32-pad, 5 x 5 x 1.0 body, Lead Pitch 0.50 mm Quad Flat No-Lead/Micro Lead Frame Package (QFN/MLF)



• Packaging Information

32A



COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	-	-	1.20	
A1	0.05	-	0.15	
A2	0.95	1.00	1.05	
D	8.75	9.00	9.25	
D1	6.90	7.00	7.10	Note 2
E	8.75	9.00	9.25	
E1	6.90	7.00	7.10	Note 2
B	0.30	-	0.45	
C	0.09	-	0.20	
L	0.45	-	0.75	
e	0.80 TYP			

- Notes:
1. This package conforms to JEDEC reference MS-026, Variation ABA.
 2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is 0.25 mm per side. Dimensions D1 and E1 are maximum plastic body size dimensions including mold mismatch.
 3. Lead coplanarity is 0.10 mm maximum.

10/5/2001



2325 Orchard Parkway
San Jose, CA 95131

TITLE

32A, 32-lead, 7 x 7 mm Body Size, 1.0 mm Body Thickness,
0.8 mm Lead Pitch, Thin Profile Plastic Quad Flat Package (TQFP)

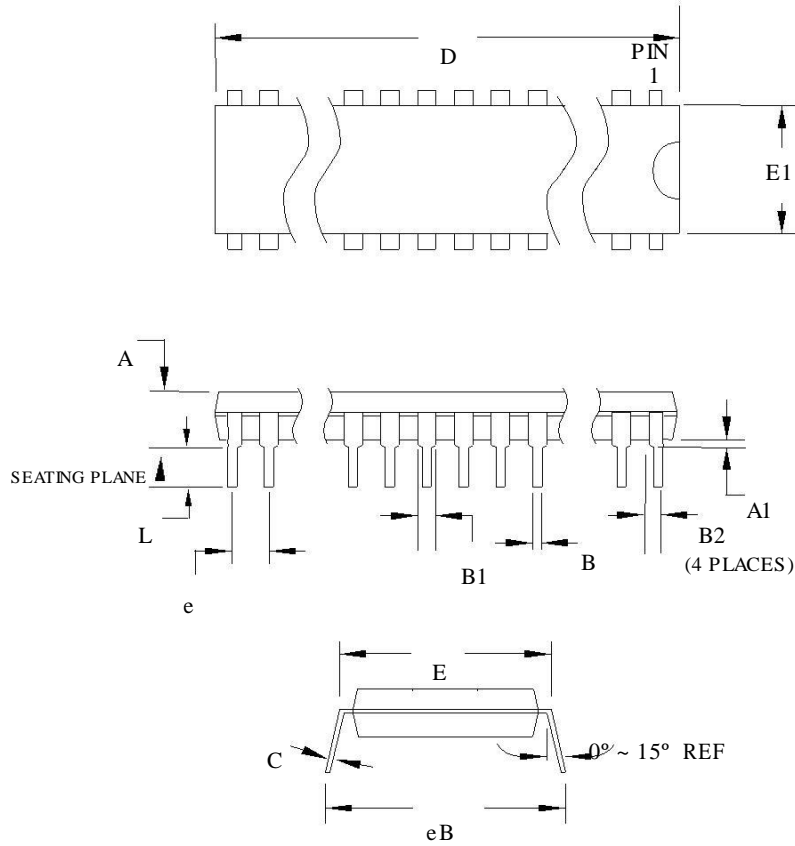
DRAWING NO.

32A

REV.

B

28P3



Note: 1. Dimensions D and E1 do not include mold Flash or Protrusion.
Mold Flash or Protrusion shall not exceed 0.25 mm (0.010").

COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	-	-	4.5724	
A1	0.508	-	-	
D	34.544	-	34.798	Note 1
E	7.620	-	8.255	
E1	7.112	-	7.493	Note 1
B	0.381	-	0.533	
B1	1.143	-	1.397	
B2	0.762	-	1.143	
L	3.175	-	3.429	
C	0.203	-	0.356	
eB	-	-	10.160	
e	2.540 TYP			

09/28/01

ATMEL
2325 Orchard Parkway
San Jose, CA 95131

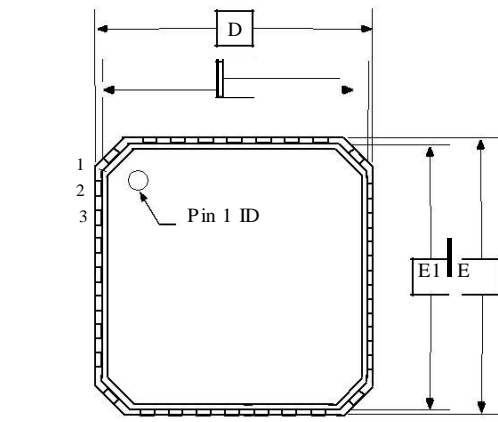
TITLE
28P3, 28-lead (0.300"/7.62 mm Wide) Plastic Dual
Inline Package (PDIP)

DRAWING NO.
28P3

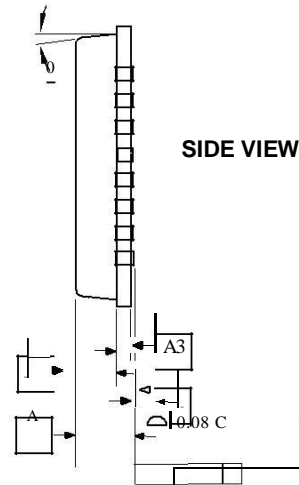
REV.
B



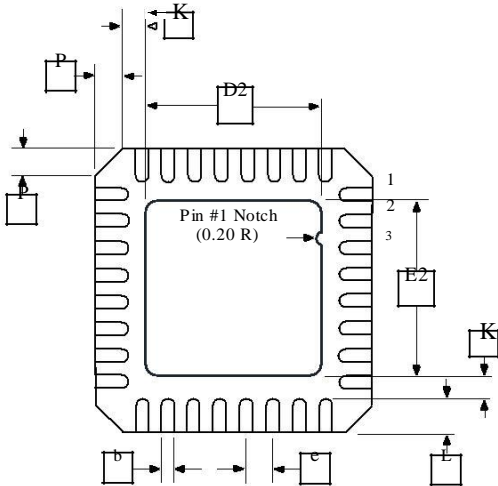
32M1-A



TOP VIEW



SIDE VIEW



BOTTOM VIEW

COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	0.80	0.90	1.00	
A1	-	0.02	0.05	
A2	-	0.65	1.00	
A3	0.20 REF			
b	0.18	0.23	0.30	
D	4.90	5.00	5.10	
D1	4.70	4.75	4.80	
D2	2.95	3.10	3.25	
E	4.90	5.00	5.10	
E1	4.70	4.75	4.80	
E2	2.95	3.10	3.25	
e	0.50 BSC			
L	0.30	0.40	0.50	
P	-	-	0.60	
θ	-	-	12 ⁰	
K	0.20	-	-	

Note: JEDEC Standard MO-220, Fig. 2 (Anvil Singulation), VHHD-2.

5/25/06

TITLE

DRAWING NO. REV.

2325 Orchard Parkway
San Jose, CA 95131

32M1-A, 32 pad, 5 x 5 x 1.0 mm Body, Lead Pitch 0.50 mm,
3.10 mm Exposed Pad, Micro Lead Frame Package (MLF)

32MI-A

E